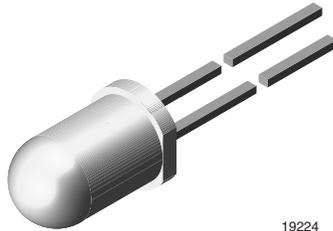


## High Efficiency LED in $\varnothing$ 5 mm Tinted Diffused Package



19224

### FEATURES

- Choice of three bright colors
- Standard T-1 $\frac{3}{4}$  package
- Small mechanical tolerances
- Suitable for DC and high peak current
- Wide viewing angle
- Luminous intensity categorized
- Yellow and green color categorized
- TLH.64.. without stand-offs
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



### DESCRIPTION

The TLH.64.. series was developed for standard applications like general indicating and lighting purposes.

It is housed in a 5 mm tinted diffused plastic package. The wide viewing angle of these devices provides a high on-off contrast.

Several selection types with different luminous intensities are offered. All LEDs are categorized in luminous intensity groups. The green and yellow LEDs are categorized additionally in wavelength groups.

That allows users to assemble LEDs with uniform appearance.

### APPLICATIONS

- Status lights
- Off/on indicator
- Background illumination
- Readout lights
- Maintenance lights
- Legend light

### PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: 5 mm
- Product series: standard
- Angle of half intensity:  $\pm 30^\circ$

PARTS TABLE		
PART	COLOR, LUMINOUS INTENSITY	TECHNOLOGY
TLHR6400	Red, $I_V = 3.5$ mcd (typ.)	GaAsP on GaP
TLHR6401	Red, $I_V = 7$ mcd (typ.)	GaAsP on GaP
TLHR6405	Red, $I_V = 10$ mcd (typ.)	GaAsP on GaP
TLHY6400	Yellow, $I_V = 3.5$ mcd (typ.)	GaAsP on GaP
TLHY6401	Yellow, $I_V = 7$ mcd (typ.)	GaAsP on GaP
TLHY6405	Yellow, $I_V = 10$ mcd (typ.)	GaAsP on GaP
TLHG6400	Green, $I_V = 4$ mcd (typ.)	GaP on GaP
TLHG6401	Green, $I_V = 7$ mcd (typ.)	GaP on GaP
TLHG6405	Green, $I_V > 15$ mcd (typ.)	GaP on GaP



<b>ABSOLUTE MAXIMUM RATINGS<sup>1)</sup> TLHR64.. , TLHY64.. , TLHG64.. ,</b>				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		$V_R$	6	V
DC Forward current	$T_{amb} \leq 65\text{ }^\circ\text{C}$	$I_F$	30	mA
Surge forward current	$t_p \leq 10\text{ }\mu\text{s}$	$I_{FSM}$	1	A
Power dissipation	$T_{amb} \leq 65\text{ }^\circ\text{C}$	$P_V$	100	mW
Junction temperature		$T_j$	100	$^\circ\text{C}$
Operating temperature range		$T_{amb}$	- 20 to + 100	$^\circ\text{C}$
Storage temperature range		$T_{stg}$	- 55 to + 100	$^\circ\text{C}$
Soldering temperature	$t \leq 5\text{ s}$ , 2 mm from body	$T_{sd}$	260	$^\circ\text{C}$
Thermal resistance junction/ambient		$R_{thJA}$	350	K/W

Note:

<sup>1)</sup>  $T_{amb} = 25\text{ }^\circ\text{C}$ , unless otherwise specified

<b>OPTICAL AND ELECTRICAL CHARACTERISTICS<sup>1)</sup> TLHR64..., RED</b>							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN	TYP.	MAX	UNIT
Luminous intensity <sup>2)</sup>	$I_F = 10\text{ mA}$	TLHR6400	$I_V$	1.6	3.5		mcd
		TLHR6401	$I_V$	4	7		mcd
		TLHR6405	$I_V$	6.3	10		mcd
Dominant wavelength	$I_F = 10\text{ mA}$		$\lambda_d$	612		625	nm
Peak wavelength	$I_F = 10\text{ mA}$		$\lambda_p$		635		nm
Angle of half intensity	$I_F = 10\text{ mA}$		$\varphi$		$\pm 30$		deg
Forward voltage	$I_F = 20\text{ mA}$		$V_F$		2	3	V
Reverse voltage	$I_R = 10\text{ }\mu\text{A}$		$V_R$	6	15		V
Junction capacitance	$V_R = 0$ , $f = 1\text{ MHz}$		$C_j$		50		pF

Note:

<sup>1)</sup>  $T_{amb} = 25\text{ }^\circ\text{C}$ , unless otherwise specified

<sup>2)</sup> In one packing unit  $I_{Vmin}/I_{Vmax} \leq 0.5$

<b>OPTICAL AND ELECTRICAL CHARACTERISTICS<sup>1)</sup> TLHY64..., YELLOW</b>							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN	TYP.	MAX	UNIT
Luminous intensity <sup>2)</sup>	$I_F = 10\text{ mA}$	TLHY6400	$I_V$	1.6	3.5		mcd
		TLHY6401	$I_V$	4	7		mcd
		TLHY6405	$I_V$	6.3	10		mcd
Dominant wavelength	$I_F = 10\text{ mA}$		$\lambda_d$	581		594	nm
Peak wavelength	$I_F = 10\text{ mA}$		$\lambda_p$		585		nm
Angle of half intensity	$I_F = 10\text{ mA}$		$\varphi$		$\pm 30$		deg
Forward voltage	$I_F = 20\text{ mA}$		$V_F$		2.4	3	V
Reverse voltage	$I_R = 10\text{ }\mu\text{A}$		$V_R$	6	15		V
Junction capacitance	$V_R = 0$ , $f = 1\text{ MHz}$		$C_j$		50		pF

Note:

<sup>1)</sup>  $T_{amb} = 25\text{ }^\circ\text{C}$ , unless otherwise specified

<sup>2)</sup> In one packing unit  $I_{Vmin}/I_{Vmax} \leq 0.5$

OPTICAL AND ELECTRICAL CHARACTERISTICS <sup>1)</sup> TLHG64.., GREEN							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN	TYP.	MAX	UNIT
Luminous intensity <sup>2)</sup>	$I_F = 10 \text{ mA}$	TLHG6400	$I_V$	1.6	4		mcd
		TLHG6401	$I_V$	4	7		mcd
		TLHG6405	$I_V$	6.3	15		mcd
Dominant wavelength	$I_F = 10 \text{ mA}$		$\lambda_d$	562		575	nm
Peak wavelength	$I_F = 10 \text{ mA}$		$\lambda_p$		565		nm
Angle of half intensity	$I_F = 10 \text{ mA}$		$\phi$		$\pm 30$		deg
Forward voltage	$I_F = 20 \text{ mA}$		$V_F$		2.4	3	V
Reverse voltage	$I_R = 10 \mu\text{A}$		$V_R$	6	15		V
Junction capacitance	$V_R = 0, f = 1 \text{ MHz}$		$C_j$		50		pF

Note:

<sup>1)</sup>  $T_{amb} = 25 \text{ }^\circ\text{C}$ , unless otherwise specified

<sup>2)</sup> In one packing unit  $I_{Vmin}/I_{Vmax} \leq 0.5$

### TYPICAL CHARACTERISTICS

$T_{amb} = 25 \text{ }^\circ\text{C}$ , unless otherwise specified

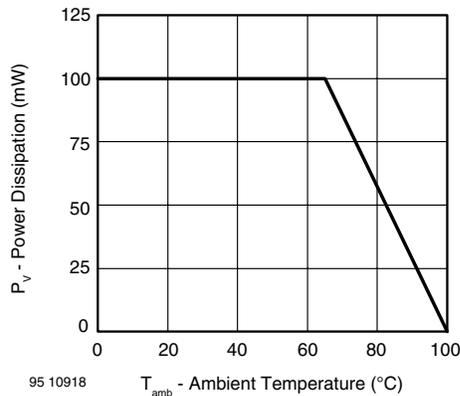


Figure 1. Power Dissipation vs. Ambient Temperature

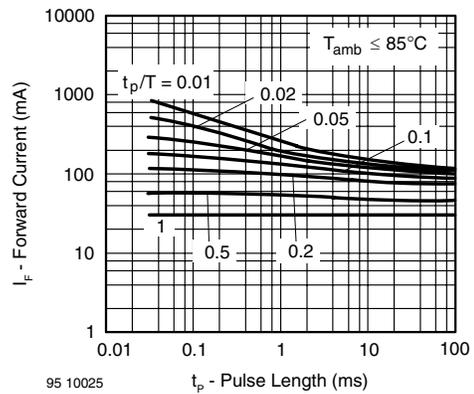


Figure 3. Forward Current vs. Pulse Length

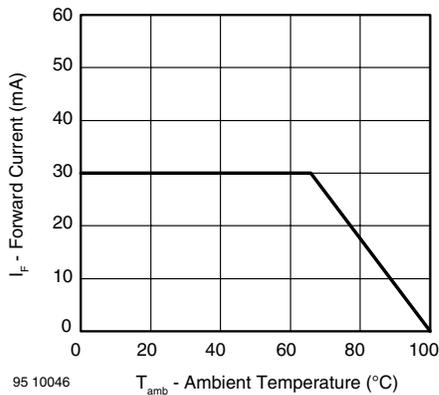


Figure 2. Forward Current vs. Ambient Temperature

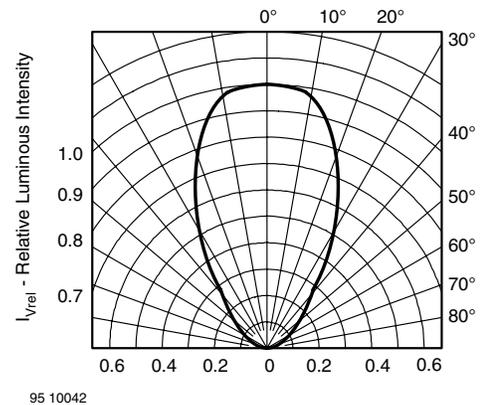


Figure 4. Rel. Luminous Intensity vs. Angular Displacement

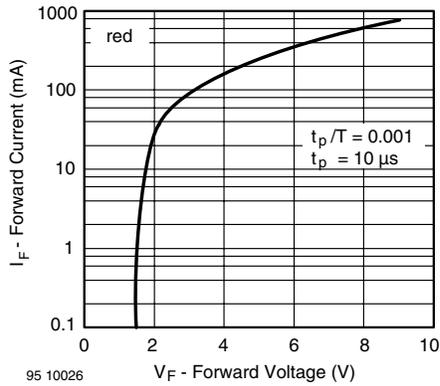


Figure 5. Forward Current vs. Forward Voltage

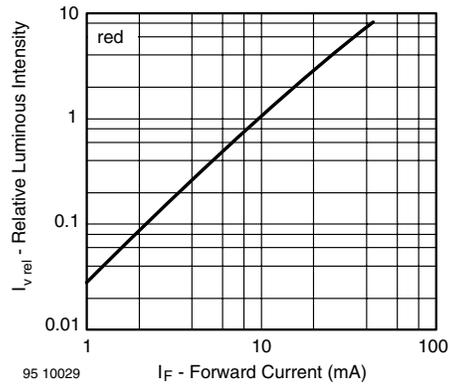


Figure 8. Relative Luminous Intensity vs. Forward Current

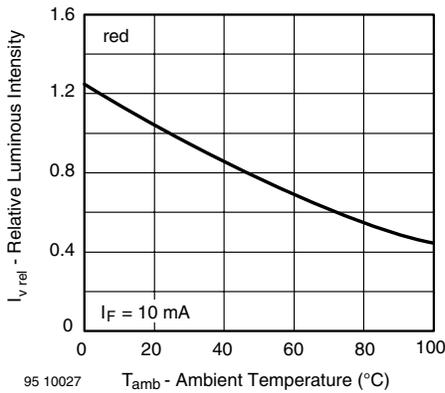


Figure 6. Rel. Luminous Intensity vs. Ambient Temperature

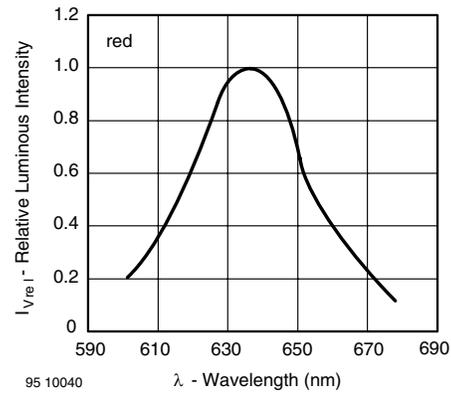


Figure 9. Relative Intensity vs. Wavelength

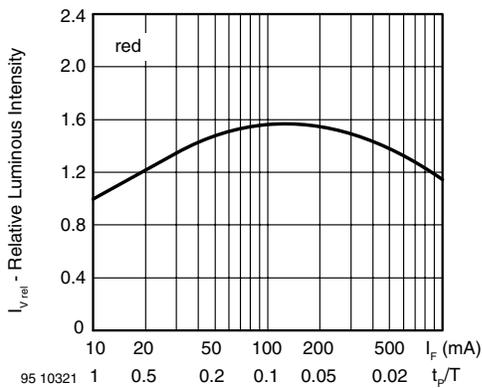


Figure 7. Rel. Lumin. Intensity vs. Forw. Current/Duty Cycle

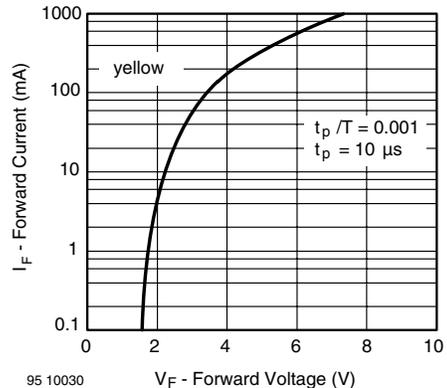


Figure 10. Forward Current vs. Forward Voltage

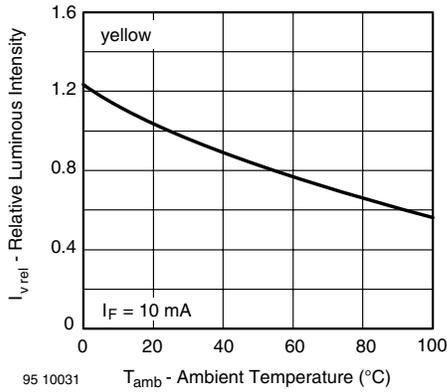


Figure 11. Rel. Luminous Intensity vs. Ambient Temperature

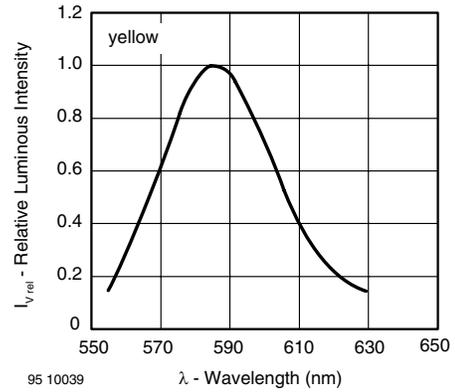


Figure 14. Relative Intensity vs. Wavelength

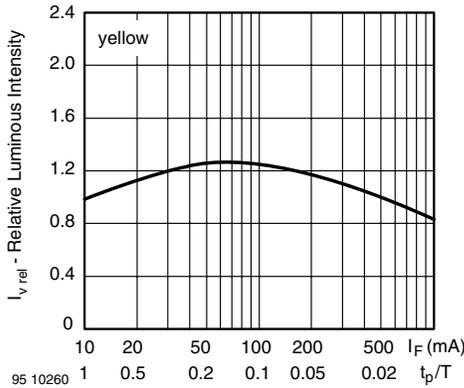


Figure 12. Rel. Lumin. Intensity vs. Forw. Current/Duty Cycle

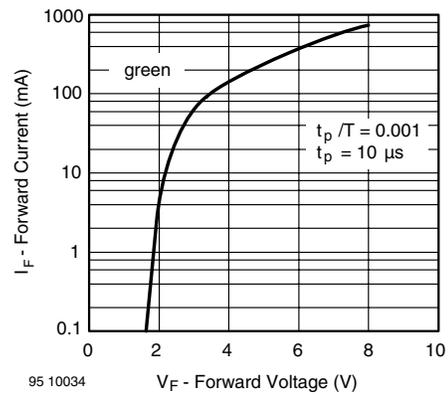


Figure 15. Forward Current vs. Forward Voltage

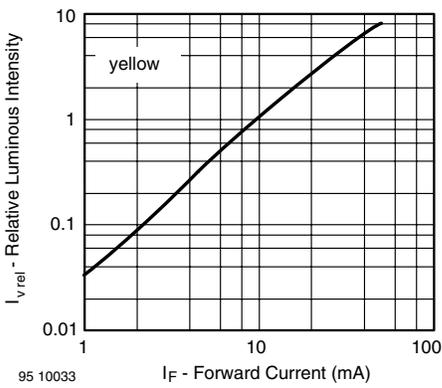


Figure 13. Relative Luminous Intensity vs. Forward Current

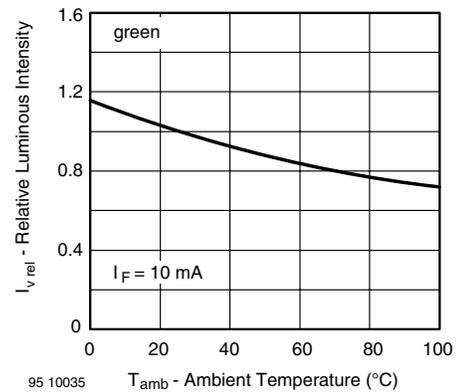


Figure 16. Rel. Luminous Intensity vs. Ambient Temperature

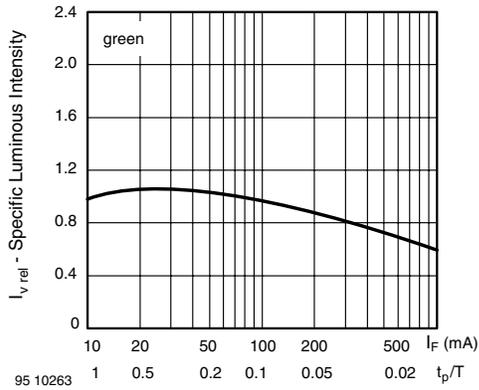


Figure 17. Specific Luminous Intensity vs. Forward Current

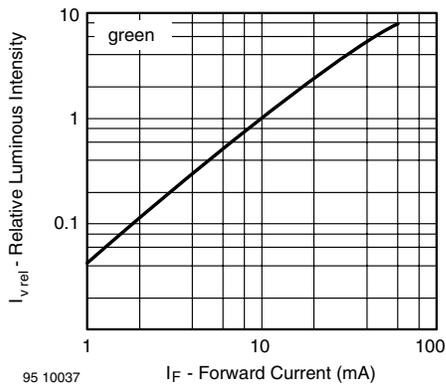


Figure 18. Relative Luminous Intensity vs. Forward Current

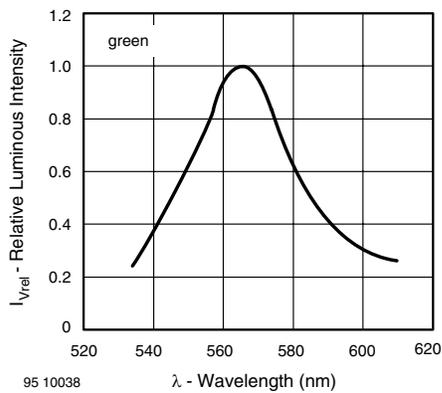


Figure 19. Relative Intensity vs. Wavelength



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It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design  
and may do so without further notice.

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